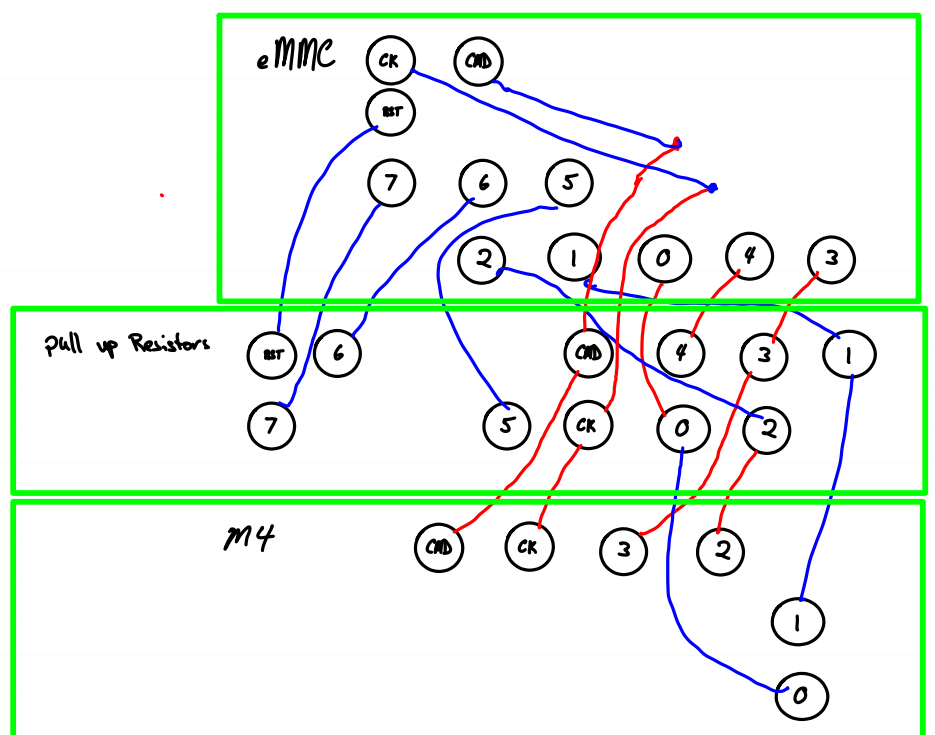


Oreset C3 v2.0

Layout Notes:

- Main goal move everything to the left side of the board
- Remove JP9 (not used), JP8 (FTDI VUSB to VBUS)
- Add flat ribbon connector to replace J7 (ARM SWD), C3_FTDI Connector
- Add From library J-TE Connectivity - X-1734592-X
Device 2-1734592-0
Footprint TE_2-1734592-0
- Make all GND and 3.3V trace width 0.3048
- Make all Non GND and 3.3V Wire width 0.254 (or 0.2 under eMMC)
- Make sure that the edge clearance is maintained
- Make all components 0603 (Resistors, Capacitors)
- Connection Plan for eMMC to arrange connections to pull up resistor networks



- Add (per Ian)
Protection Circuit
for OPD

0 ohm resistor (as placeholder) for protection circuit.
Make symbol and footprint for TVS diode
Little fuse SZ1SMB5.0AT3G